STP7LN80K5



N-channel 800 V, 0.95 Ω typ., 5 A MDmesh™ K5 Power MOSFET in a TO-220 package

Datasheet - production data

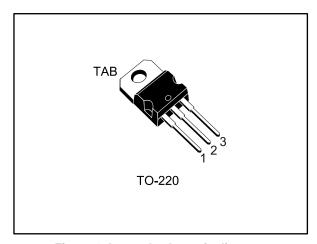
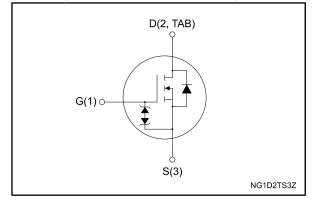


Figure 1: Internal schematic diagram



Features

Order code	V _{DS}	R _{DS(on)} max.	I _D
STP7LN80K5	800 V	1.15 Ω	5 A

- Industry's lowest R_{DS(on)} x area
- Industry's best figure of merit (FoM)
- Ultra-low gate charge
- 100% avalanche tested
- Zener-protected

Applications

• Switching applications

Description

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STP7LN80K5	7LN80K5	TO-220	Tube

Contents STP7LN80K5

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STP7LN80K5 Electrical ratings

1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V _{GS}	Gate-source voltage	± 30	V
I _D	Drain current (continuous) at T _C = 25 °C	5	Α
I _D	Drain current (continuous) at T _C = 100 °C	3.4	Α
I _D ⁽¹⁾	Drain current (pulsed)	20	Α
P _{TOT}	Total dissipation at T _C = 25 °C	85	W
dv/dt ⁽²⁾	Peak diode recovery voltage slope	4.5	V/ns
dv/dt ⁽³⁾	MOSFET dv/dt ruggedness	50	V/ns
T _{stg}	Storage temperature	FF to 150	°C
Tj	Operating junction temperature	- 55 to 150	C

Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case	1.47	°C/W
R _{thj-amb}	Thermal resistance junction-ambient	62.5	°C/W

Table 4: Avalanche characteristics

Symbol	Parameter	Value	Unit
I _{AR}	$I_{AR} \qquad \text{Avalanche current, repetetive or not repetetive (pulse width limited by T_{jmax})} \\ E_{AS} \qquad \text{(Single pulse avalanche energy (starting $T_j = 25 ^{\circ}$C,} \\ I_{D} = I_{AR}; V_{DD} = 50 \text{V)} \\ \end{cases}$		А
E _{AS}			mJ

 $[\]ensuremath{^{(1)}}\mbox{Pulse}$ width limited by safe operating area.

 $^{^{(2)}}I_{SD} \leq 5$ A, di/dt ≤ 100 A/µs; V_{DS} peak $\leq V_{(BR)DSS},~V_{DD} = 400~V$

⁽³⁾V_{DS} ≤ 640 V

Electrical characteristics STP7LN80K5

2 Electrical characteristics

T_C = 25 °C unless otherwise specified

Table 5: On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	800			٧
	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$			1	μΑ
I _{DSS}		$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V},$ $T_{C} = 125 \text{ °C}$			50	μΑ
I _{GSS}	Gate-body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			±10	μΑ
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 100 \mu A$	3	4	5	V
R _{DS(on)}	Static drain-source on-resistance	V _{GS} = 10 V, I _D = 2.5 A		0.95	1.15	Ω

Table 6: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance		-	270	-	pF
Coss	Output capacitance	V _{DS} = 100 V, f = 1 MHz,	-	22	1	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0 V$	-	0.5	-	pF
C _{o(er)} ⁽¹⁾	Equivalent capacitance energy related		-	17	-	nC
C _{o(tr)} (2)	Equivalent capacitance time related	$V_{DS} = 0$ to 640 V, $V_{GS} = 0$ V	-	48	-	nC
R_{G}	Intrinsic gate resistance	f = 1 MHz, I _D =0 A	-	7.5	-	Ω
Q_g	Total gate charge	$V_{DD} = 640 \text{ V}, I_D = 5 \text{ A}, V_{GS} = 10 \text{ V}$	-	12	-	nC
Q_{gs}	Gate-source charge	(see Figure 15: "Test circuit for	-	2.6	1	nC
Q_{gd}	Gate-drain charge	gate charge behavior")	-	8.6	1	nC

Notes:

Table 7: Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time	$V_{DD} = 400 \text{ V}, I_D = 2.5 \text{ A},$	ı	9.3	ı	ns
t _r	Rise time	$R_G = 4.7 \Omega$, $V_{GS} = 10 V$ (see <i>Figure</i>		6.7	-	ns
t _{d(off)}	Turn-off-delay time	14: "Test circuit for resistive load switching times" and Figure 19:	-	23.6	-	ns
t _f	Fall time	"Switching time waveform")	-	17.4	-	ns

 $^{^{(1)}}$ Energy related is defined as a constant equivalent capacitance giving the same stored energy as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

 $^{^{(2)}}$ Time related is defined as a constant equivalent capacitance giving the same stored energy as C_{oss} when V_{DS} increases from 0 to 80% V_{DSS}

Table 8: Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I _{SD}	Source-drain current		-		5	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		20	Α
V _{SD} ⁽²⁾	Forward on voltage	I _{SD} = 5 A, V _{GS} = 0 V	-		1.6	V
t _{rr}	Reverse recovery time	I _{SD} = 5 A, di/dt = 100 A/μs,	-	276		ns
Q _{rr}	Reverse recovery charge	V _{DD} = 60 V (see Figure 16: "Test circuit for inductive load	-	2.13		μC
I _{RRM}	Reverse recovery current	switching and diode recovery times")	-	15.4		А
t _{rr}	Reverse recovery time	I _{SD} = 5 A, di/dt = 100 A/µs,	-	402		ns
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, T_j = 150 \text{ °C}$ (see Figure 16: "Test circuit for	-	2.79		μC
I _{RRM}	Reverse recovery current	inductive load switching and diode recovery times")	-	13.9		Α

Notes:

Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)GSO}$	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_{D} = 0 \text{ A}$	30	-		V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

⁽¹⁾Pulse width is limited by safe operating area

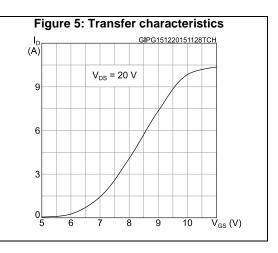
 $^{^{(2)}}$ Pulsed: pulse duration = 300 μ s, duty cycle 1.5%

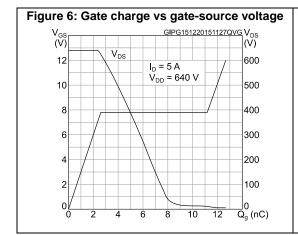
 $\overline{V}_{DS}(V)$

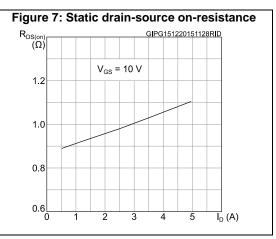
2.2 Electrical characteristics (curves)

T_o= 25°C single pulse

10⁻²___







STP7LN80K5 Electrical characteristics

Figure 8: Capacitance variations

C
(pF)

10³

10²

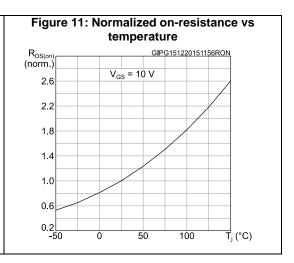
10¹

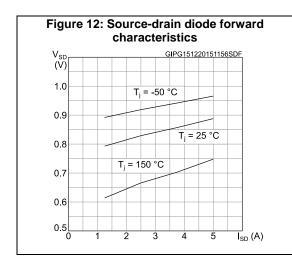
f = 1 MHz

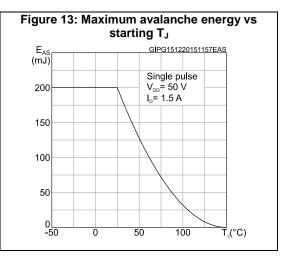
Coss
CRSS

10⁻¹

1







Test circuits STP7LN80K5

3 Test circuits

Figure 14: Test circuit for resistive load switching times

Figure 14: Test circuit for resistive load switching times

Figure 14: Test circuit for resistive load switching times

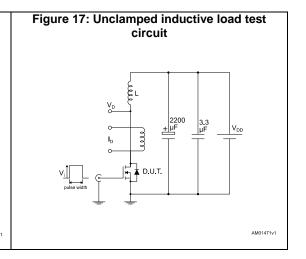
Figure 15: Test circuit for gate charge behavior

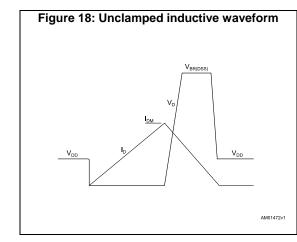
12 V 47 kΩ 100 nF D.U.T.

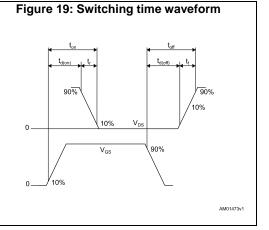
2200 PF 47 kΩ OVG

AM01466y1

Figure 16: Test circuit for inductive load switching and diode recovery times







STP7LN80K5 Package information

4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.

4.1 TO-220 type A package information

Figure 20: TO-220 type A package outline

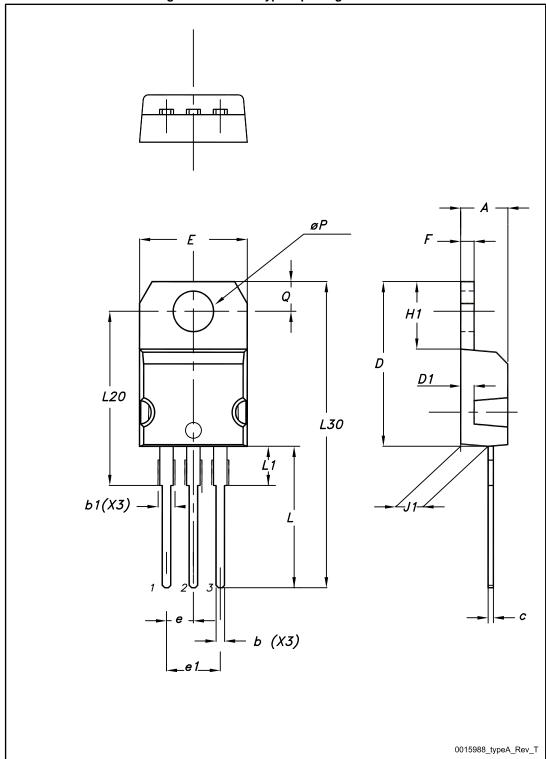


Table 10: TO-220 type A mechanical data

Dim	mm				
Dim.	Min.	Тур.	Max.		
Α	4.40		4.60		
b	0.61		0.88		
b1	1.14		1.70		
С	0.48		0.70		
D	15.25		15.75		
D1		1.27			
E	10		10.40		
е	2.40		2.70		
e1	4.95		5.15		
F	1.23		1.32		
H1	6.20		6.60		
J1	2.40		2.72		
L	13		14		
L1	3.50		3.93		
L20		16.40			
L30		28.90			
øΡ	3.75		3.85		
Q	2.65		2.95		

Revision history STP7LN80K5

5 Revision history

Table 11: Document revision history

Date	Revision	Changes
08-Jan-2016	1	First release.

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